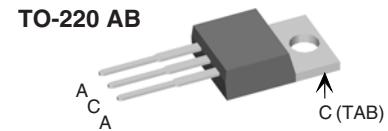
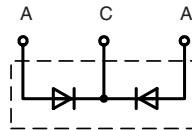


Power Schottky Rectifier with common cathode

$I_{FAV} = 2 \times 10 \text{ A}$
 $V_{RRM} = 45 \text{ V}$
 $V_F = 0.56 \text{ V}$

V_{RSM}	V_{RRM}	Type
V	V	
45	45	DSSK 20-0045A



A = Anode, C = Cathode , TAB = Cathode

Symbol	Conditions	Maximum Ratings		Features
I_{FRMS}		35	A	
I_{FAV}	$T_C = 160^\circ\text{C}$; rectangular, $d = 0.5$	10	A	
I_{FAV}	$T_C = 160^\circ\text{C}$; rectangular, $d = 0.5$; per device	20	A	
I_{FSM}	$T_{VJ} = 45^\circ\text{C}$; $t_p = 10 \text{ ms}$ (50 Hz), sine	140	A	
E_{AS}	$I_{AS} = 13 \text{ A}$; $L = 180 \mu\text{H}$; $T_{VJ} = 25^\circ\text{C}$; non repetitive	24	mJ	
I_{AR}	$V_A = 1.5 \cdot V_{RRM}$ typ.; $f = 10 \text{ kHz}$; repetitive	1.3	A	
$(dv/dt)_{cr}$		1000	V/ μ s	
T_{VJ}		-55...+175	°C	
T_{VJM}		175	°C	
T_{stg}		-55...+150	°C	
P_{tot}	$T_C = 25^\circ\text{C}$	90	W	
M_d	mounting torque	0.4...0.6	Nm	
Weight	typical	2	g	

Features

- International standard package
- Very low V_F
- Extremely low switching losses
- Low I_{RM} -values
- Epoxy meets UL 94V-0

Applications

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

Advantages

- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching
- Low losses

Dimensions see Outlines.pdf

Symbol	Conditions	Characteristic Values	
		typ.	max.
I_R ①	$V_R = V_{RRM}$; $T_{VJ} = 25^\circ\text{C}$ $V_R = V_{RRM}$, $T_{VJ} = 125^\circ\text{C}$	0.3 2.5	mA mA
V_F	$I_F = 10 \text{ A}$; $T_{VJ} = 125^\circ\text{C}$ $I_F = 10 \text{ A}$; $T_{VJ} = 25^\circ\text{C}$ $I_F = 20 \text{ A}$; $T_{VJ} = 125^\circ\text{C}$	0.56 0.68 0.69	V V V
R_{thJC} R_{thCH}		0.5	1.7 K/W K/W

Pulse test: ① Pulse Width = 5 ms, Duty Cycle < 2.0%

Data according to IEC 60747 and per diode unless otherwise specified.

Recommended replacement:
DSA20C45PB/DSA30C45PB

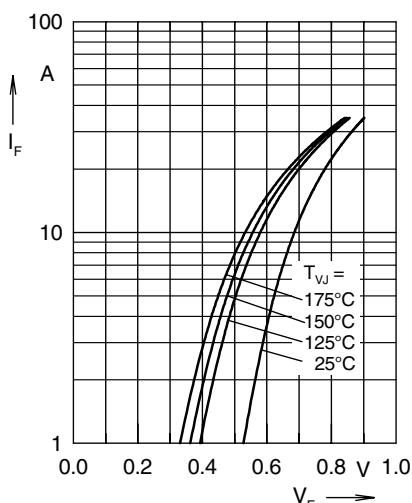


Fig. 1 Maximum forward voltage drop characteristics

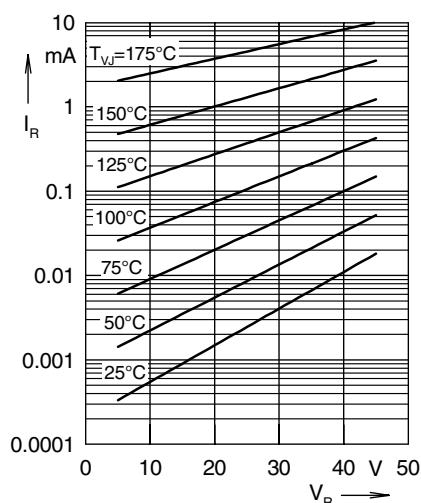


Fig. 2 Typ. value of reverse current I_R versus reverse voltage V_R

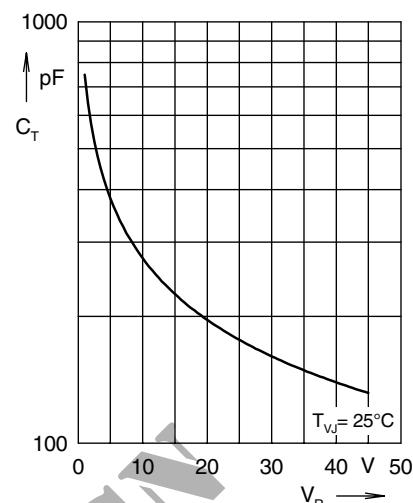


Fig. 3 Typ. junction capacitance C_T versus reverse voltage V_R

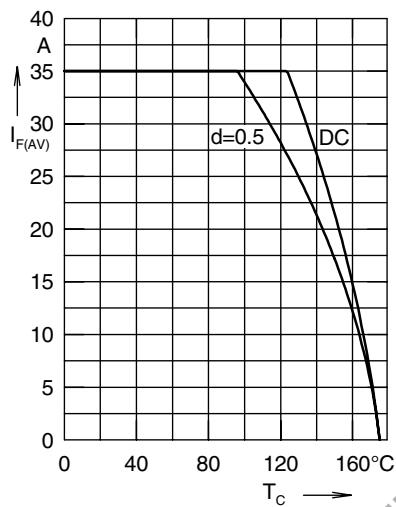


Fig. 4 Average forward current $I_{F(AV)}$ versus case temperature T_C

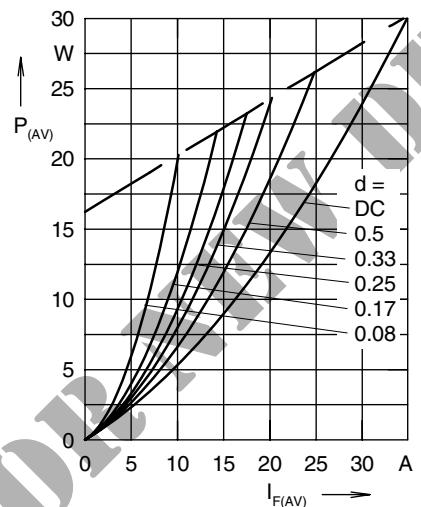


Fig. 5 Forward power loss characteristics

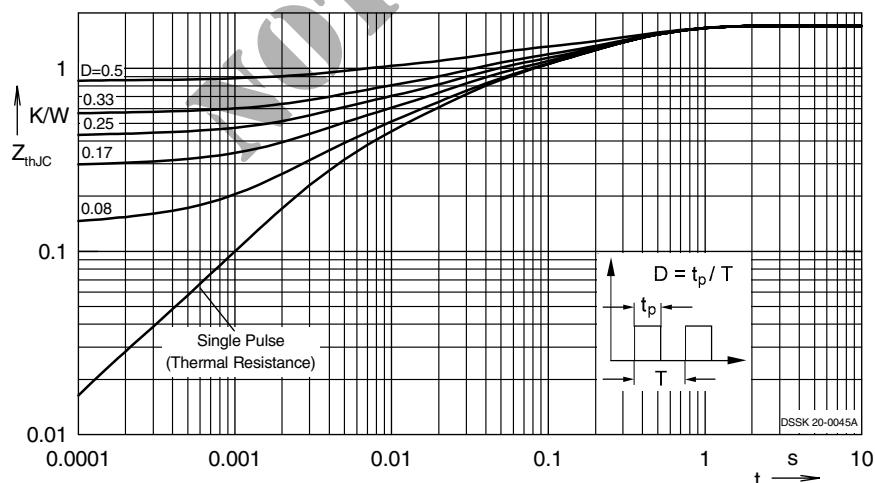


Fig. 6 Transient thermal impedance junction to case at various duty cycles

Note: All curves are per diode

IXYS reserves the right to change limits, Conditions and dimensions.